Ohm's law: V=IR

Resistivity: p = RA surface Area

The amount of Voltage flowing across a conductor is directly proportional to the current flowing provided constant conditions

- · Resistance per unit length & Ao.
- · Independent of geometry & sample

Conductivity:

Electrical Resistance:

· Reciprocal of resistivity

· Depends on the geometry & size of sample

Metals

2) Semi - conductors conductivity

3) Ceramics

4) Polymers

Cursent density: J= 6E

Amount of current flowing through Ao. I to I

Fox constant Electric field,

V= Work b3=V

Electric field potential: E = V

units= Nm = J = Volts = Fd

= Fd Fe



Subject:	/ /
·Semiconductors:	
· Narrow bard gap	
·Thus, es able to jump to higher empty energy states	
empty conduction band GAP  filled valence band	Energy —>
Valence band  filled band  Chapter 18 - 15	Interatomic separation
Influence of temps imperfections on posteristivity	
· Presence of impusitions such as grain boundaries, displining atoms, vacancies & These scatter of path	locations,
P = Pt + Pimpurity + Pactormation	
Drift velocity:	
· Aug velocity of ē in the direction of the force imposed by applied field.	
Va = UE  Selection mobility	
Types of electronic charge:	
1) Free & -> In conduction band (-ev)	
2) Hole - In valence band (tev)	

4	Subject:
4	Inteinsiz Semi-Conductors:
9	· Puxe semi - conductor
4	
1	Example:
4	Siz Ge
4	111-V compounds => InSb
4	11-VI compounds-2nTe
7	
1	NOTE:
1	Electronegativity difference & band gap
9	Conductivity: 6= Nelle + plellh -> hole mobility
*	Conductivity: 6= Nelle + Delle + Delle
1	woodility modellity
4	(Mas 2 # holles
1	
4	Fox intrinsic semi-conductor,
7	n = p = n; intrinsic carrier concentration
1	6 = Nilel(Me+Mh)
1	C = (Me + Mh)
9	
*	Si:
1	56 increases with T
4	LAH RTP, it acts as insulator. On increasing T, is excite & thus
9	Si acts as conductor.
4	1
7	— Egap/KT
4	n: «e
1	Due to increased contrains blue
9	Conductors &
*	
4	cti
1	Semiconductors Semiconductors
9	Semicon-
4	Insulators
7	
1	Temperature
1	

	9	
(	9	Subject:
(	9	Externsic:
	9	
		· Roperties determined by impurities induced holes & Es.
0		0 <del>+</del> p
3		- 17 P
0		
3		n-type Extrinsic: (n>>p) P-type Extrinsic: (p>>n)
3		The chististice (1374)
3		
3		6= n/elle 6= p/ellh
2		6= Nelle 6= plellh
2		
2		· Doping increases conductivity because imperfections lower
2		, ,
2		activation energy levels.
2		· For T:
2		
7		· < 100, Nothing happens - es don't move
7		
7		· 150 < T < 450: extrinsio - Doped holesles play crucial role
7		· >> 450: intrinsic-Inherent holes les play crucial role
7		
7		
7		P-N Rechifying region:
7		
7		
7		· Allows flow of current in only one direction.
7		^
7		No applied potential:
7		Lano current flow
7		
7		
7		Forward bias:
7		
7		Sexternal V applied, es from n region move to p region
7		I won bine with holes.
7		
7		hus, cussent flows.
7		
7		0
7	•	Leverse bias:
7		Lo External V applied on opposite direction, es don't move.
7		
7		La Depletion region widers.
7		
-		

0	
7	Subject:
1	Transistors:
1	1/Q1/5/5/085:
4	
7	La Amplification
7	- SAMPLITICATION)
7	
7	Junction 1 Junction 2
7	Emitter Base Collector
7	Q.B.
7	
7	P A Severage Distriction of the series of th
7	
7	
7	F.B.  Output
7	Time Time
7	Time
7	
7	Piezoelectoic materials:
7	
7	
7	· Stress induces V
7	
7	$=$ $\wedge$ $\wedge$ $\wedge$
7	Fessoelectric material:
7	
7	
1	exhibit spontaneous polarization  Re-allign beyond it's curie temp
1	of all a bound it's more toom
4	· ke-allight beyond 113 cubie temp
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4	
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